



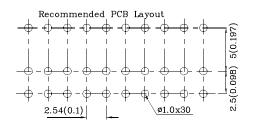


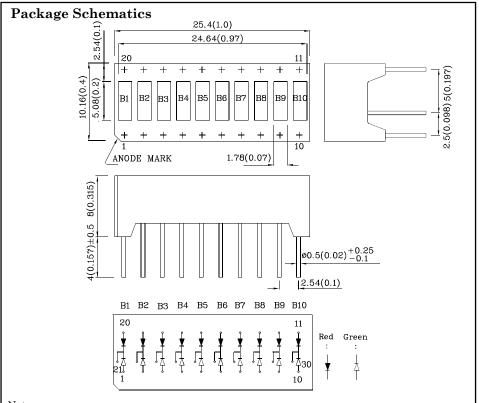
Features

- Robust package
- ullet Uniform light disbursement
- Ideal for backlighting logos or icons
- Excellent for flush mounting
- Standard configuration: Gray face w/ white segments
- RoHS compliant









1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.

2. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Red (GaAsP/ GaP)	Green (GaP)	Unit
Reverse Voltage	$V_{\rm R}$	5	5	V
Forward Current	I_{F}	30	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	160	140	mA
Power Dissipation	P_{D}	75	62.5	mW
Operating Temperature	T_{A}	-40 ~	°C	
Storage Temperature	Tstg	-40 ~		
Lead Solder Temperature [2mm Below Package Base]	260°C For 3~5 Seconds			

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Red (GaAsP/GaP)	Green (GaP)	Un it
Forward Voltage (Typ.) (I _F =10mA)	V_{F}	1.9	2	V
Forward Voltage (Max.) (I _F =10mA)	V_{F}	2.3	2.4	V
Reverse Current (Max.) (V _R =5V)	I_R	10	10	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	λР	627*	565*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =10mA)	λD	617*	568*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	Δλ	45	30	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* (IF=10mA) ucd		Wavelength CIE127-2007* nm λP	Description
			min.	typ.		
XGURUGX10D	Red	GaAsP/GaP	3600 900*	8990 1990*	627*	10 Segments
	Green	GaP	5600 1400*	11990 3990*	565*	Bar graph-Display

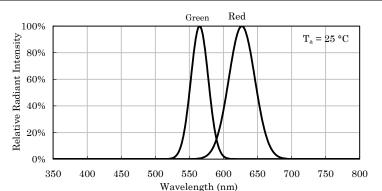
^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Nov 10,2018

XDSA1917 V9-X Layout: Maggie L.

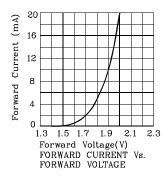


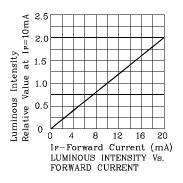


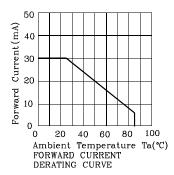


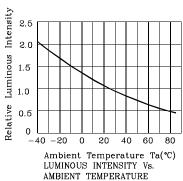
Relative Intensity Vs. CIE Wavelength

Red

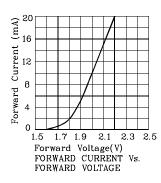


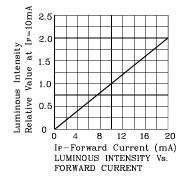


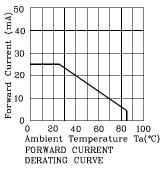


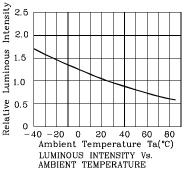


Green

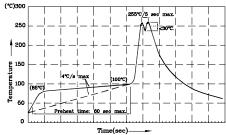








Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- ore-heat temperature of 105°C or less (as measured attached to the LED pins) prior to immersion in the maximum solder bath temperature of 260°C
- not apply stress to the epoxy resin while the temperature is above 85°C. tures should not incur stress on the component when mounting and
- Adving soldering process

 SAC 305 solder alloy is recommended.

 6.No more than one wave soldering pass.

 7.During wave soldering, the PCS top-surface temperature should be kept below 105°C.

Remarks:

If special sorting is required (e.g. binning based on forward voltage,

luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

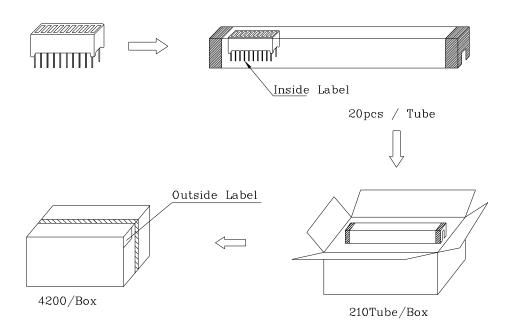
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.





PACKING & LABEL SPECIFICATIONS





TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
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- 7. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp